Onsemi

Octal 3-State Noninverting Transparent Latch with LSTTL Compatible Inputs

High-Performance Silicon-Gate CMOS

MC74HCT573A

The MC74HCT573A is identical in pinout to the LS573. This device may be used as a level converter for interfacing TTL or NMOS outputs to High-Speed CMOS inputs.

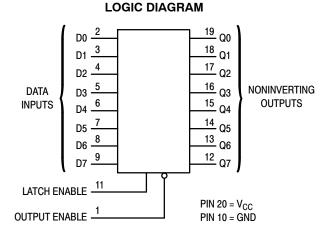
These latches appear transparent to data (i.e., the outputs change asynchronously) when Latch Enable is high. When Latch Enable goes low, data meeting the setup and hold times becomes latched.

The Output Enable input does not affect the state of the latches, but when Output Enable is high, all device outputs are forced to the high-impedance state. Thus, data may be latched even when the outputs are not enabled.

The HCT573A is identical in function to the HCT373A but has the Data Inputs on the opposite side of the package from the outputs to facilitate PC board layout.

Features

- Output Drive Capability: 15 LSTTL Loads
- TTL/NMOS-Compatible Input Levels
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 10 µA
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 234 FETs or 58.5 Equivalent Gates
 - Improved Propagation Delays
 - ◆ 50% Lower Quiescent Power
- These Devices are Pb-Free and are RoHS Compliant







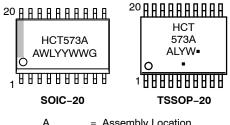
SOIC-20 **DW SUFFIX** CASE 751D

TSSOP-20 DT SUFFIX CASE 948E

PIN ASSIGNMENT

OUTPUT				
ENABLE C	1.	20	þ	V _{CC}
D0 [2	19	þ	Q0
D1 [3	18	þ	Q1
D2 C	4	17	þ	Q2
D3 D	5	16	þ	Q3
D4 C	6	15	þ	Q4
D5 C	7	14	þ	Q5
D6 D	8	13	þ	Q6
D7 C	9	12	þ	Q7
GND D	10	11	þ	LATCH
				ENABLE

MARKING DIAGRAMS



A	= Assembly Location
WL, L	= Wafer Lot
YY, Y	= Year
WW, W	= Work Week
G or ∎	= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]				
MC74HCT573ADWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel				
MC74HCT573ADTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel				
MC74HCT573ADWG	SOIC-20 (Pb-Free)	38 Units / Rail				
NLV74HCT573ADTRG	TSSOP-20 (Pb-Free)	2500 / Tape & Reel				
NLV74HCT573ADWG	SOIC-20 (Pb-Free)	38 Units / Rail				
NLV74HCT573ADWRG	SOIC-20 (Pb-Free)	1000 / Tape & Reel				

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

FUNCTION TABLE

	Inputs		
Output Enable		D	Q
L	Н	Н	Н
L	Н	L	L
L	L	X	No Change
н	Х	X	Z

X = Don't Care

Z = High Impedance

Design Criteria	Value	Units
Internal Gate Count*	58.5	ea
Internal Gate Propagation Delay	1.5	ns
Internal Gate Power Dissipation	5.0	μW
Speed Power Product	0.0075	рJ

*Equivalent to a two-input NAND gate.

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to + 7.0	V
V _{in}	DC Input Voltage (Referenced to GND)	-0.5 to V _{CC} + 0.5	V
V _{out}	DC Output Voltage (Referenced to GND)	–0.5 to V _{CC} + 0.5	V
l _{in}	DC Input Current, per Pin	±20	mA
I _{out}	DC Output Current, per Pin	±25	mA
I _{CC}	DC Supply Current, V _{CC} and GND Pins	±50	mA
P _D	Power Dissipation in Still Air SOIC Package† TSSOP Package†	500 450	mW
T _{stg}	Storage Temperature	–65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds (TSSOP or SOIC Package)	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating: SOIC Package: -7 mW/°C from 65° to 125°C

TSSOP Package: -6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V _{in} , V _{out}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	V
T _A	Operating Temperature, All Package Types	-55	+125	°C
t _r , t _f	Input Rise and Fall Time (Figure 1)	0	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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		Gua				uaranteed Limit		
Symbol	Parameter	Test Conditions	V _{CC} V	–55 to 25°C	≤ 85°C	≤ 125°C	Unit	
V _{IH}	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ I_{out} \leq 20 \ \mu\text{A} \end{array}$	4.5 5.5	2.0 2.0	2.0 2.0	2.0 2.0	V	
V _{IL}	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ I_{out} \leq 20 \ \mu\text{A} \end{array}$	4.5 5.5	0.8 0.8	0.8 0.8	0.8 0.8	V	
V _{OH}	Minimum High-Level Output Voltage	$ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ I_{out} \leq 20 \ \mu A \end{array} $	4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V	
			4.5	3.98	3.84	3.7		
V _{OL}	Maximum Low-Level Output Voltage	$ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left I_{out} \right \leq 20 \ \mu A \end{array} $	4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V	
		$ \begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ I_{out} \leq 6.0 \text{ mA} \end{array} $	4.5	0.26	0.33	0.4		
l _{in}	Maximum Input Leakage Current	V _{in} = V _{CC} or GND	5.5	±0.1	±1.0	±1.0	μΑ	
I _{OZ}	Maximum Three-State Leakage Current	Output in High–Impedance State $V_{in} = V_{IL}$ or V_{IH} $V_{out} = V_{CC}$ or GND	5.5	±0.5	±5.0	±10	μΑ	
I _{CC}	Maximum Quiescent Supply Current (per Package)		5.5	4.0	40	160	μΑ	
ΔI_{CC}	Additional Quiescent Supply Current	$V_{in} = 2.4$ V, Any One Input $V_{in} = V_{CC}$ or GND, Other Inputs		≥ 55°C	25°C to 125°C			
	Gunon	$I_{out} = 0 \mu A$	5.5	2.9	2	.4	mA	

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 5.0 V $\pm 10\%,~C_L$ = 50 pF, Input t_r = t_f = 6.0 ns)

			Guaranteed Limit			
Symbol	Parameter	–55 to 25°C	≤ 85 °C	≤ 125°C	Unit	
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Input D to Output Q (Figures 1 and 5)	30	38	45	ns	
t _{PLH} t _{PHL}	Maximum Propagation Delay, Latch Enable to Q (Figures 2 and 5)	30	38	45	ns	
T _{PLZ,} T _{PHZ}	Maximum Propagation Delay, Output Enable to Q (Figures 3 and 6)	28	35	42	ns	
t _{TZL,} t _{TZH}	Maximum Propagation Delay, Output Enable to Q (Figures 3 and 6)	28	35	42	ns	
t _{TLH} , t _{THL}	Maximum Output Transition Time, any Output (Figures 1 and 5)	12	15	18	ns	
C _{in}	Maximum Input Capacitance	10	10	10	pF	
C _{out}	Maximum Three-State Output Capacitance (Output in High-Impedance State)	15	15	15	pF	
i		Туріс	al @ 25°C, V	_{CC} = 5.0 V		

 C_{PD}
 Power Dissipation Capacitance (Per Enabled Output)*

 * Used to determine the no-load dynamic power consumption: P_D = C_{PD} V_{CC}²f + I_{CC} V_{CC}.
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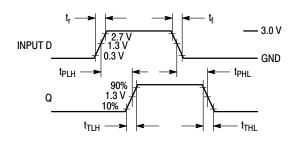
TIMING REQUIREMENTS (V_{CC} = 5.0 V $\pm 10\%,\,C_L$ = 50 pF, Input t_r = t_f = 6.0 ns)

			Guaranteed Limit						
			–55 to 25°C		$-55 \text{ to } 25^{\circ}\text{C} \leq 85^{\circ}\text{C}$		≤ 125°C		
Symbol	Parameter	Fig.	Min	Max	Min	Max	Min	Max	Unit
t _{su}	Minimum Setup Time, Input D to Latch Enable	4	10		13		15		ns
t _h	Minimum Hold Time, Latch Enable to Input D	4	5.0		5.0		5.0		ns
tw	Minimum Pulse Width, Latch Enable	2	15		19		22		ns
t _r , t _f	Maximum Input Rise and Fall Times	1		500		500		500	ns

pF

MC74HCT573A

SWITCHING WAVEFORMS





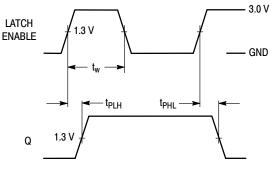


Figure 2.

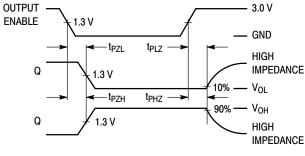
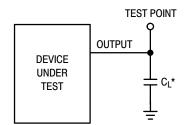
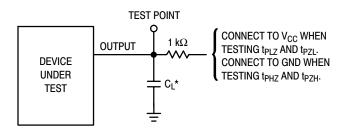


Figure 3.



*Includes all probe and jig capacitance

Figure 5. Test Circuit



*Includes all probe and jig capacitance



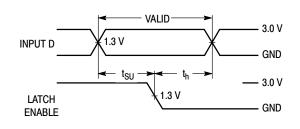
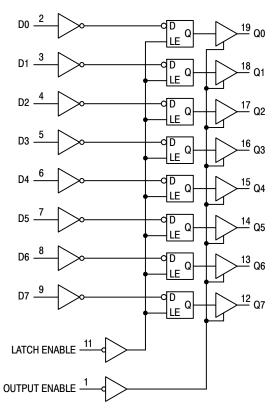


Figure 4.



EXPANDED LOGIC DIAGRAM

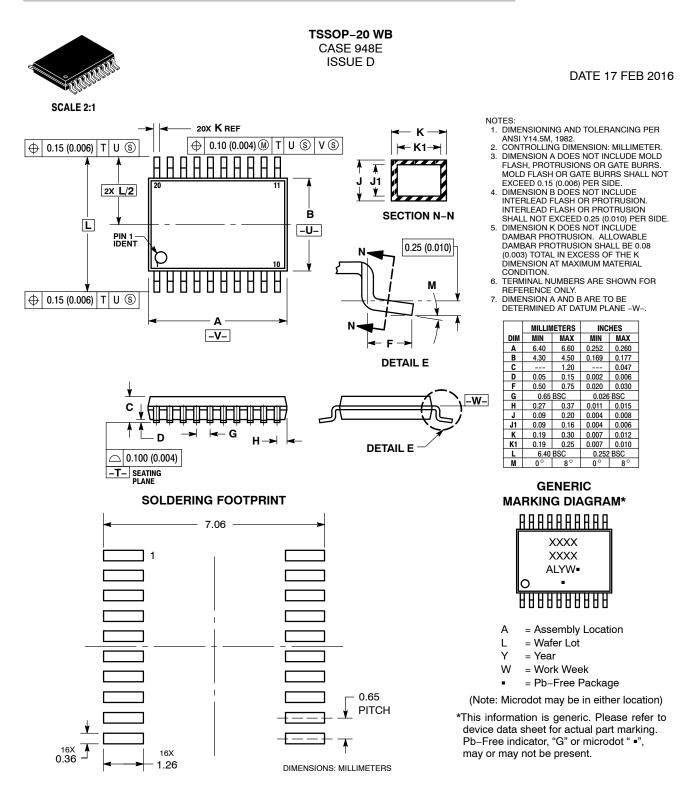
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